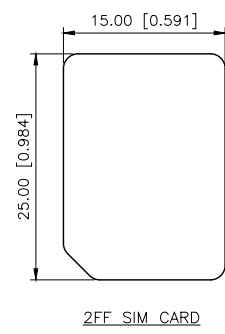


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.05.15	阿树

A.Material:
1.Insulator: Hing temperature thermoplastic
UL94V-0(BLACK LCP)
2.Pho.Bronze: Plating,40u"MIN nikel underplated
CONTACT AREA: Au 1u"
SOLDER AREA: 80u" TIN
B.Electrical specifications
Voltage rating: 12V AC
Current rating: 0.5A
Dielectric strength: 250V AC for 1 minute min
Insulation resistance: 500MΩ
Contact resistance: 50mΩ max
Operation, temperature: -40°C TO 105°C
Product withstanding rflow soldering 260°C for 10S
C.Mechanical specifications: Durability: 5000cycles

RECOMMEND PCB LAYOUT
TOLERANCE ± 0.05MM



②	Terminal	6	COPPER ALLOY	
①	Housing	1	LCP UL 94V-0	BLACK
ITEM	PAPT	NAMF	QTY	MATERIAL
				FINISHING

DESIGN	阿树	VIEW:	⊙	MODEL TYPE:	SIM CARD CONN
CHECKED		UNIT:	mm/in	PART NO.:	XKSIM-011B-P6
APPROVED		SIZE:	A4	DWG NO.:	X-XKSIM-011B-P6
XKB INDUSTRIAL PRECISION CO.,LIMITED				SCALE	PAGE
				N/A	1/1
				REVISION	A1

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	

